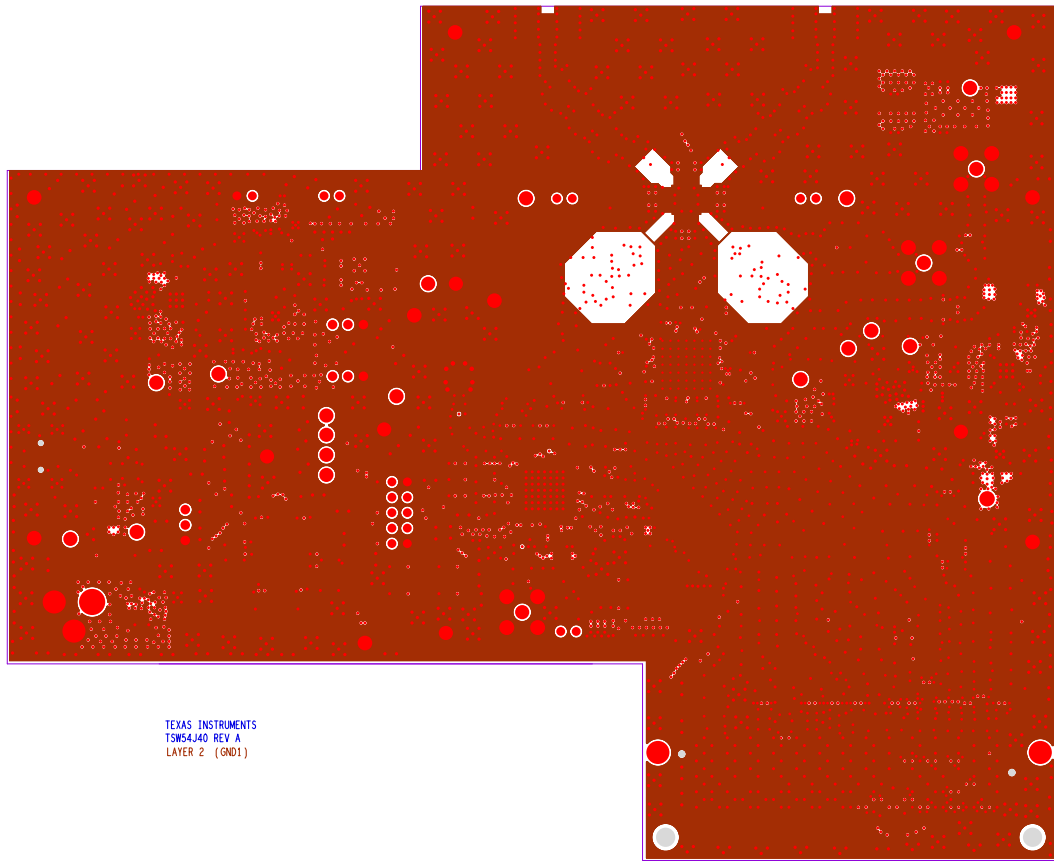
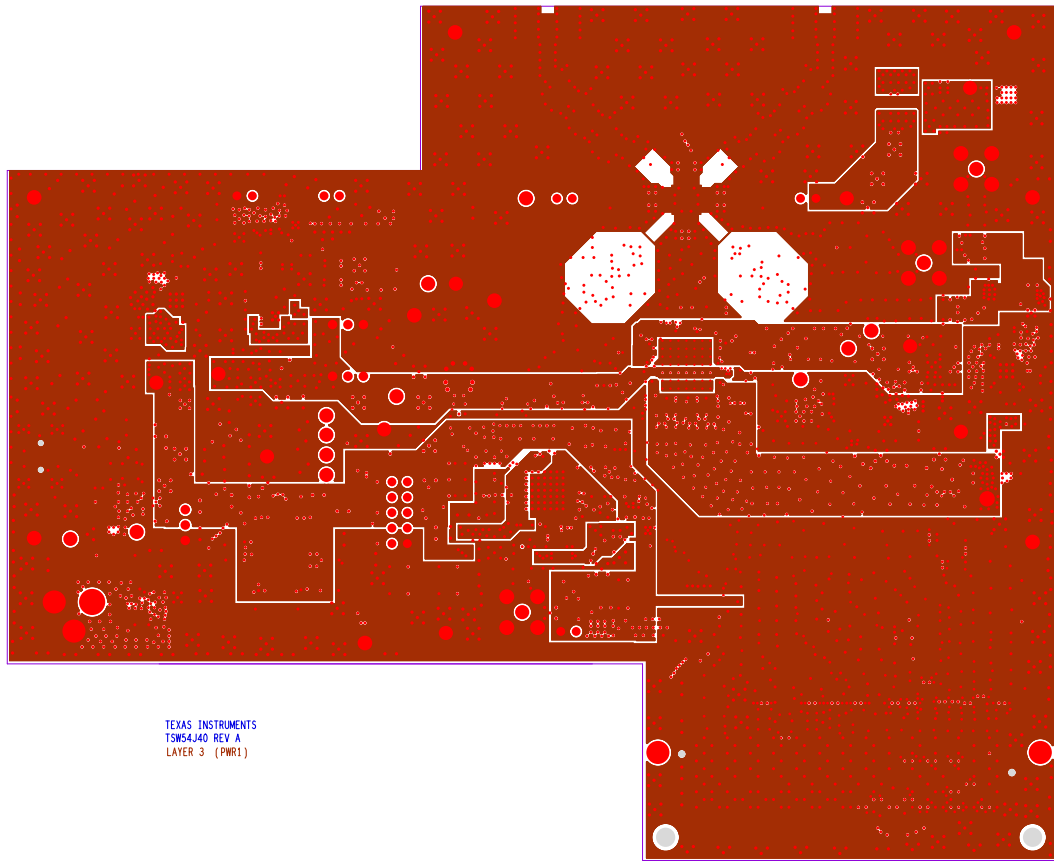
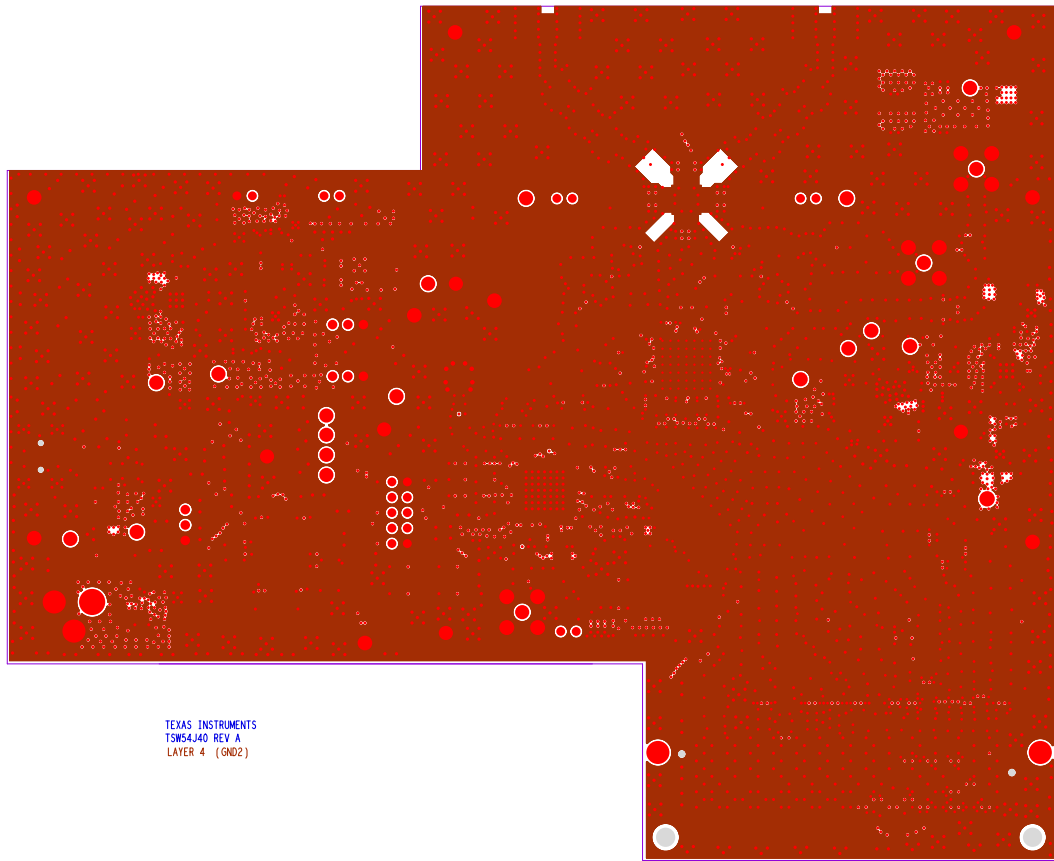


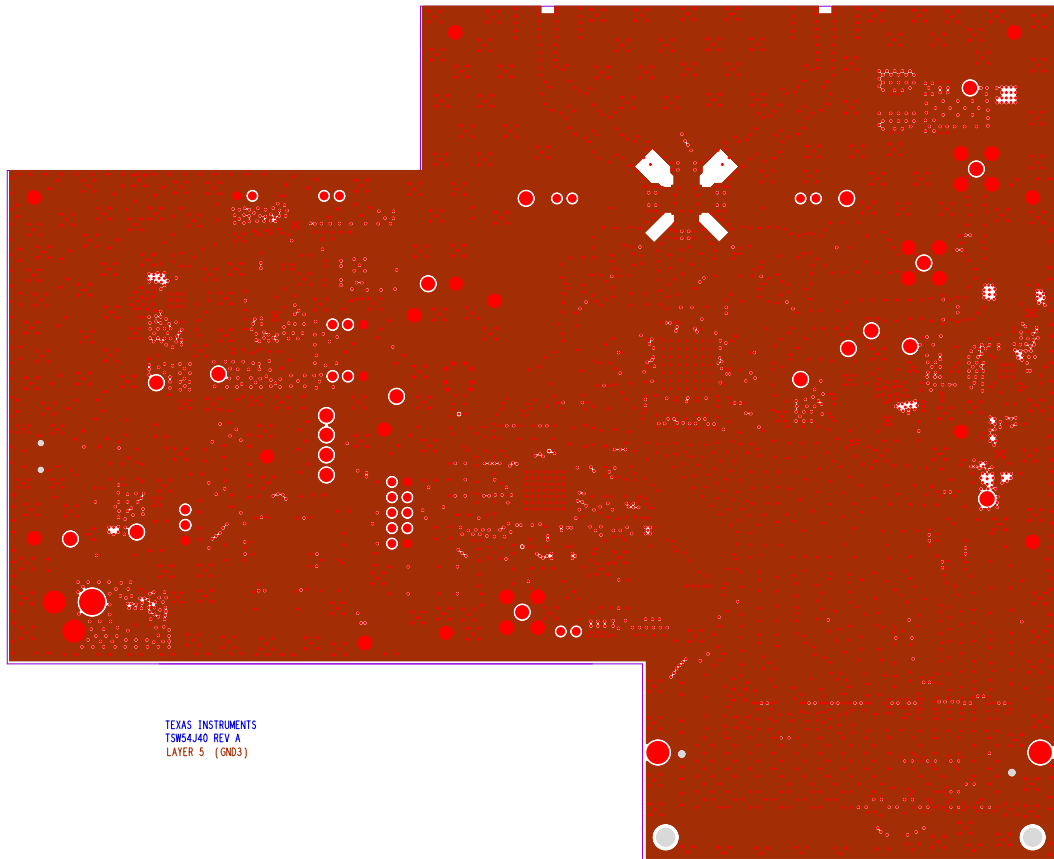
TEXAS INSTRUMENTS
 TSW5440 REV A
 BOARD (RENTOP SIDE)



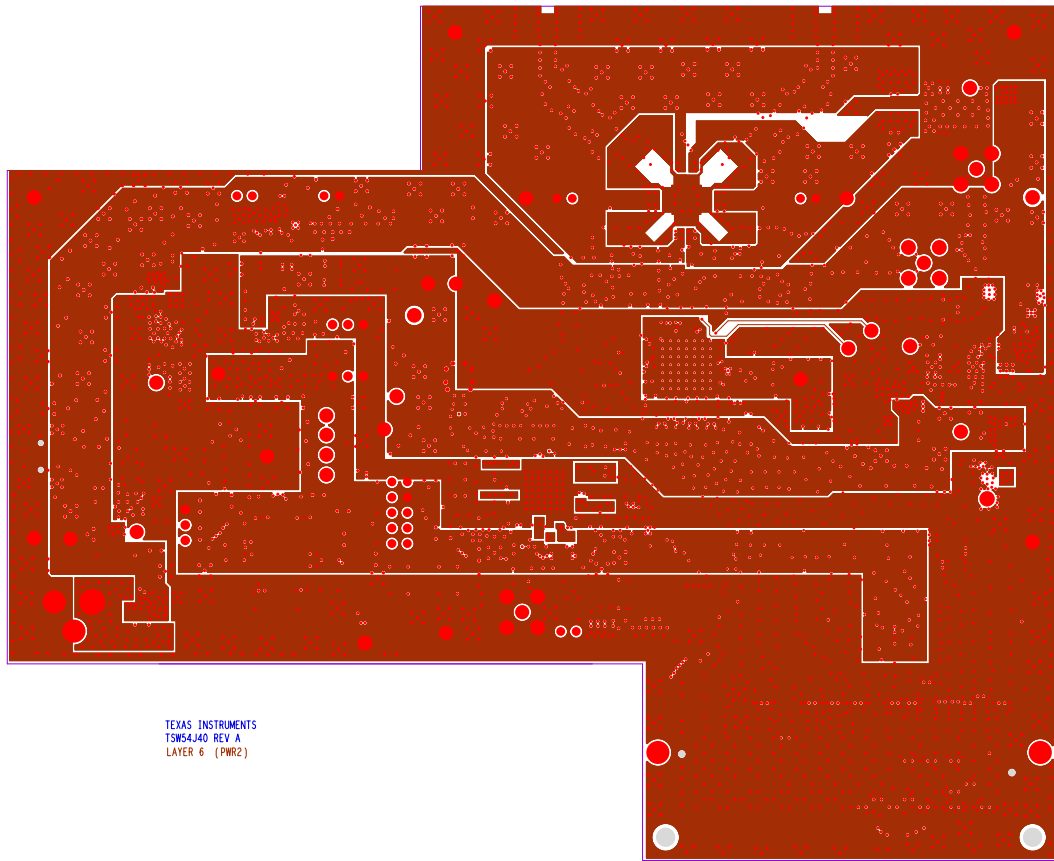




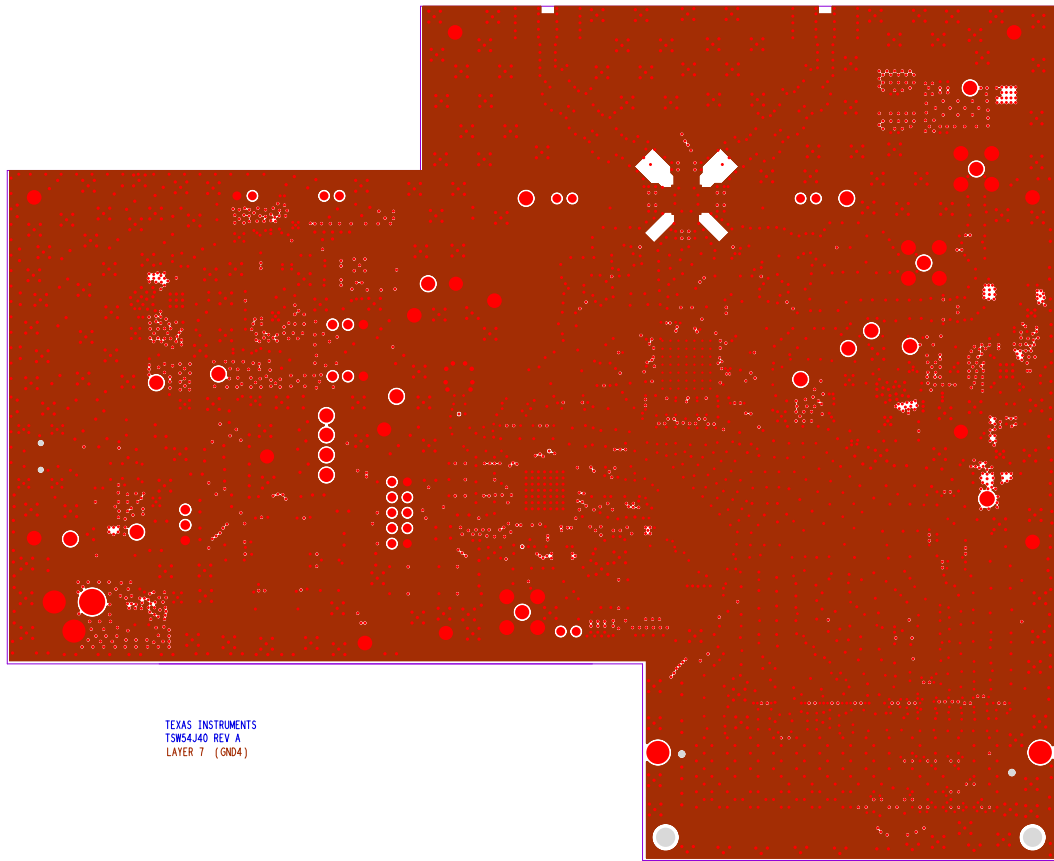
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TSM64J40 REV. A
LAYER 4 (GND2)



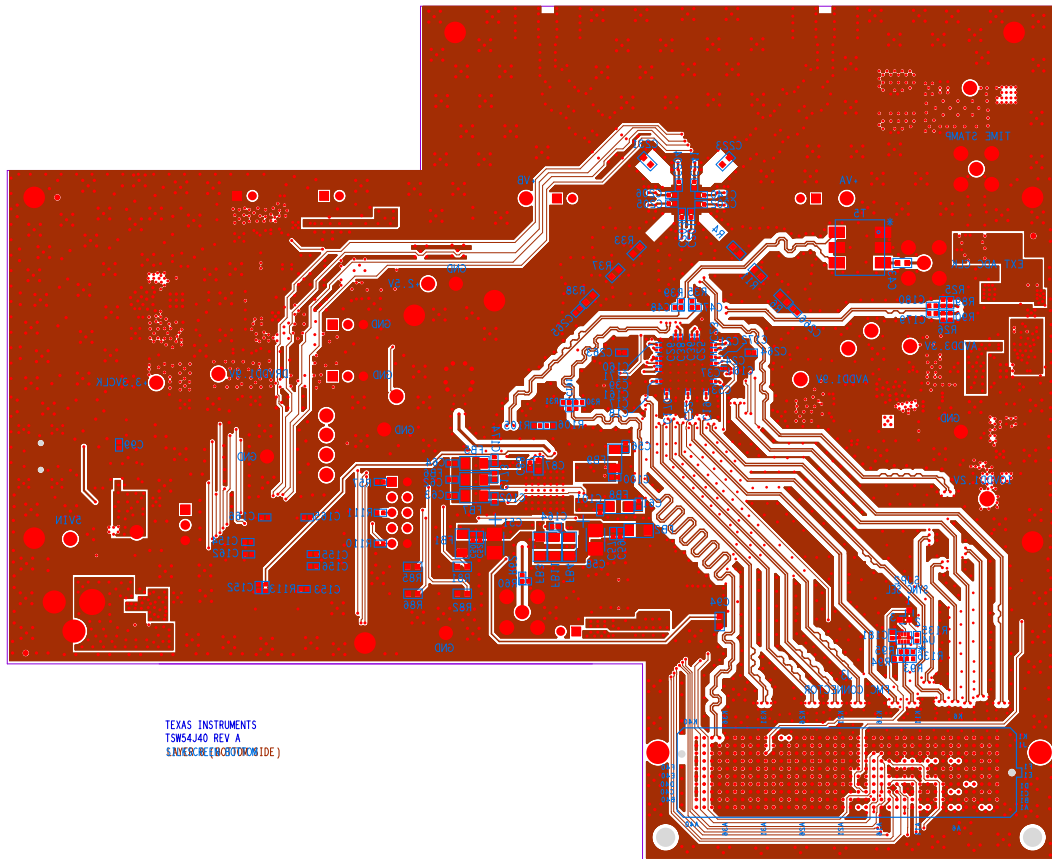
TEXAS INSTRUMENTS
TSM6440 REV A
LAYER 5 (GND3)



TEXAS INSTRUMENTS
TSM54J40 REV A
LAYER 6 (PWR2)



TEXAS INSTRUMENTS
TSM64J40 REV A
LAYER 7 (GND4)



TEXAS INSTRUMENTS
TSMS440 REV A
LSNVE6R.RE (R030700010E)

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